

Title (en)

PROTRUSION MOLDING DEVICE, PROTRUSION MOLDING METHOD, AND MOLDED ARTICLE

Title (de)

PROTRUSIONSMOLDFORMVORRICHTUNG, PROTRUSIONSMOLDVERFAHREN UND FORMARTIKEL

Title (fr)

DISPOSITIF DE MOULAGE DE SAILLIE, PROCÉDÉ DE MOULAGE DE SAILLIE ET ARTICLE MOULÉ

Publication

EP 3320997 A1 20180516 (EN)

Application

EP 16821299 A 20160629

Priority

- JP 2015135834 A 20150707
- JP 2016124835 A 20160623
- JP 2016069332 W 20160629

Abstract (en)

Provided are a protrusion forming device, a protrusion forming method, and a formed article, with which a height equal to or greater than the plate thickness is possible, the edges are sharp, and cracking can be prevented. This protrusion forming device (1) is characterized by being equipped with a die unit (12) provided with a die hole (12a), and a punch unit (40) having a large punch part (41) with a size such that this part cannot be inserted into the die hole (12a), and a small punch part (42) that protrudes from the large punch part (41) toward the die unit (12) and can be inserted into the die hole (12a), and characterized in that the workpiece (W) is deformed by pressing a portion of the workpiece arranged between the die unit (12) and the punch unit (40) toward the die unit (12) by means of the punch unit (40), thereby forming a protrusion (W1).

IPC 8 full level

B21J 5/02 (2006.01); **B21D 22/02** (2006.01)

CPC (source: EP US)

B21D 22/02 (2013.01 - EP US); **B21D 28/16** (2013.01 - EP US); **B21D 28/26** (2013.01 - US); **B21D 28/343** (2013.01 - EP US);
B21D 37/12 (2013.01 - EP US); **B21D 53/28** (2013.01 - EP US); **B21J 5/02** (2013.01 - US); **B21K 1/30** (2013.01 - EP US);
B21K 23/00 (2013.01 - EP US)

Cited by

CN113751649A; CN110076255A

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

DOCDB simple family (publication)

EP 3320997 A1 20180516; EP 3320997 A4 20190220; AU 2016291507 A1 20180215; CN 107921521 A 20180417; JP 2017019015 A 20170126;
JP 6673760 B2 20200325; TW 201706048 A 20170216; TW I727959 B 20210521

DOCDB simple family (application)

EP 16821299 A 20160629; AU 2016291507 A 20160629; CN 201680051174 A 20160629; JP 2016124835 A 20160623;
TW 105120957 A 20160701